

SFB 290 B3 Determination of Growth- and Structural Parameters of
Single Crystal Metal- and Alloy Films

Structure and Energetics of Silver /Copper-Alloy Films on a Rhenium(0001) Surface

Ronald Wagner, Rudolf Cames, Klaus Christmann

Content:

- Introduction and motivation
- Results of the sub- Ag + Cu- bilayer Ag-TPD measurements
- Results of the LEED measurements
- Summary and future work

Main questions:

What is an alloy?

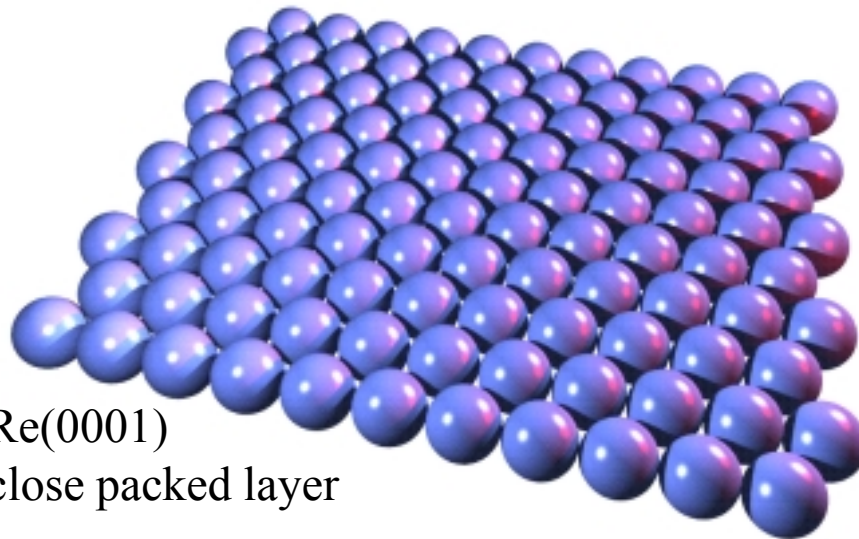
Why does the silver-copper 3D system have a wide miscibility gap?

Is it possible to overcome this gap and if yes, how?

An alloy is a mixture of metals.

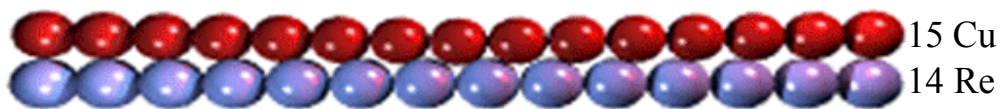
Alloys can be a homogeneous solid solutions (mixed crystals) in which metal atoms are distributed statistically in the lattice.

Usage of two-dimensionality and lattice registry for inducing alloying

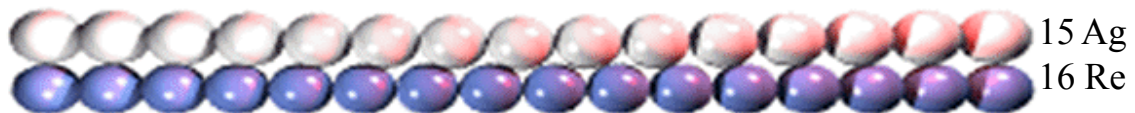


Compound	Nearest Neighbour Distance	Ratio of Radii
	ReRe	276.1pm
AgAg	288.9pm	105%
CuCu	255.6pm	93%
CuAg	272.2pm	98.6%

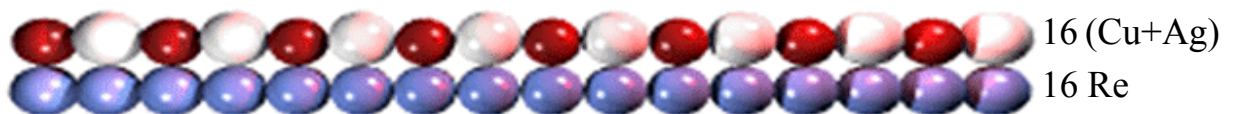
incommensurate, relaxed Cu/Re bilayer (experimental observed)



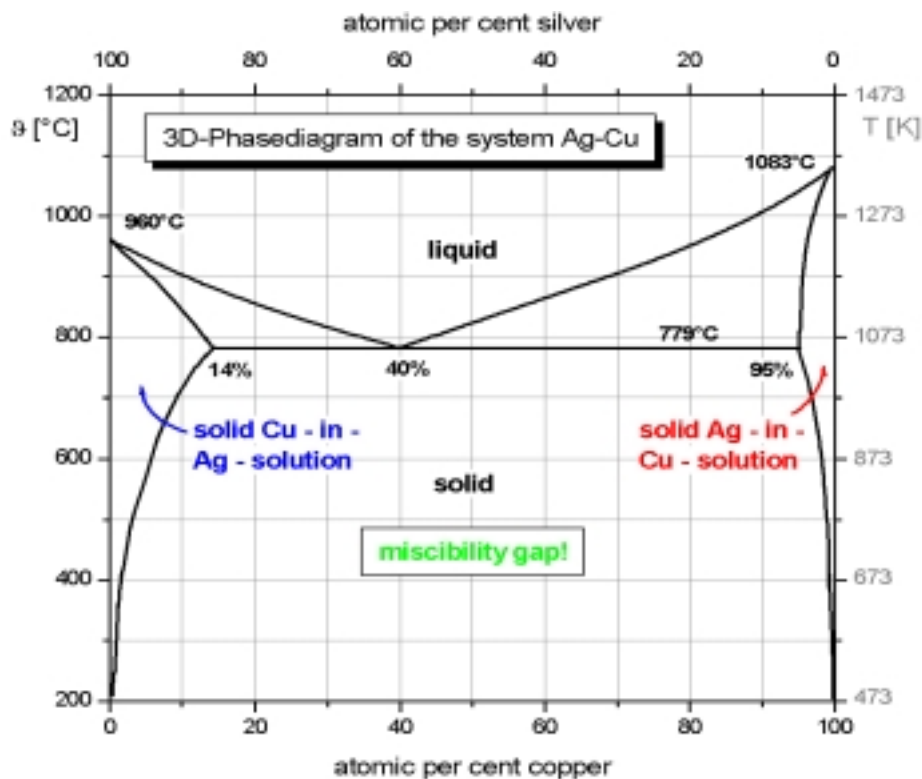
incommensurate, relaxed Ag/Re bilayer (virtual)



commensurate, relaxed Ag+Cu/Re bilayer (hypotetical)



The copper-silver bulk system



Requirements for mixed crystals:

Both metals must belong to the same lattice-type

silver: fcc, copper: fcc

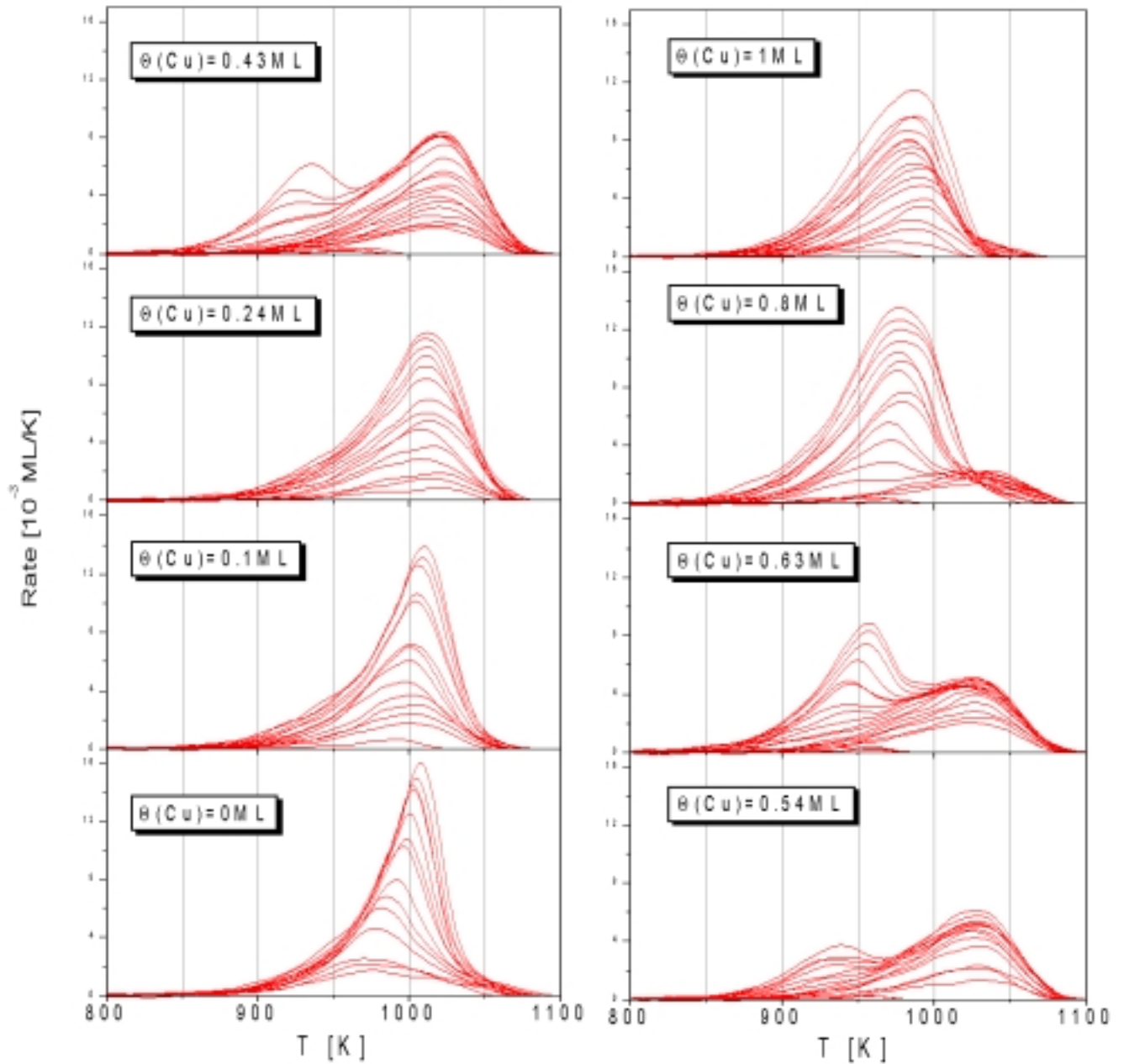
The difference of radii has to be less than 15%

silver/copper: 13%

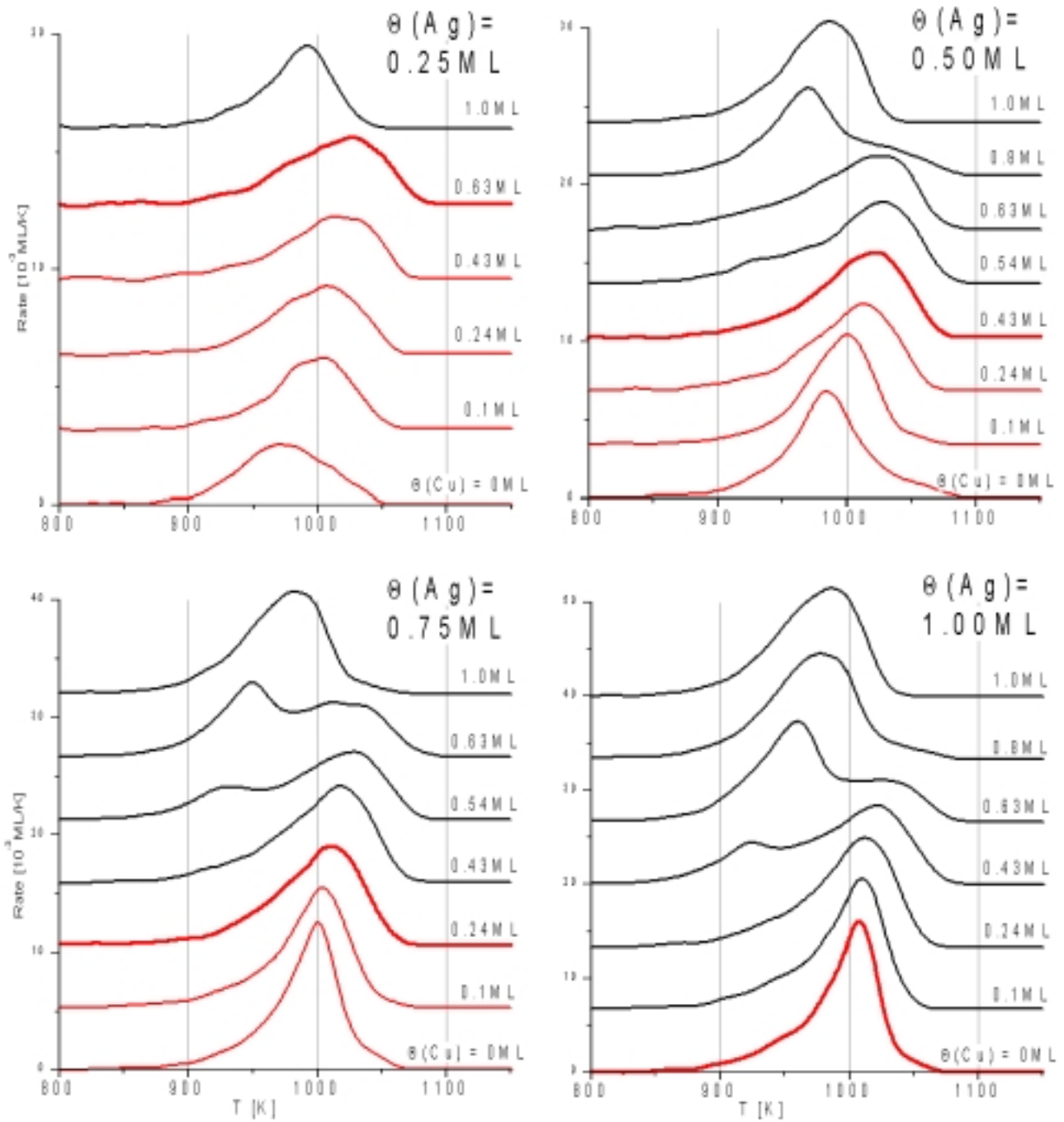
Both metals should exhibit similar electronegativities

silver: 1.93, copper 1.90

Ag-TPD-spectra Ag/Cu/Re(0001), $\beta=4.1\text{K/s}$ main parameter: Cu precoverage

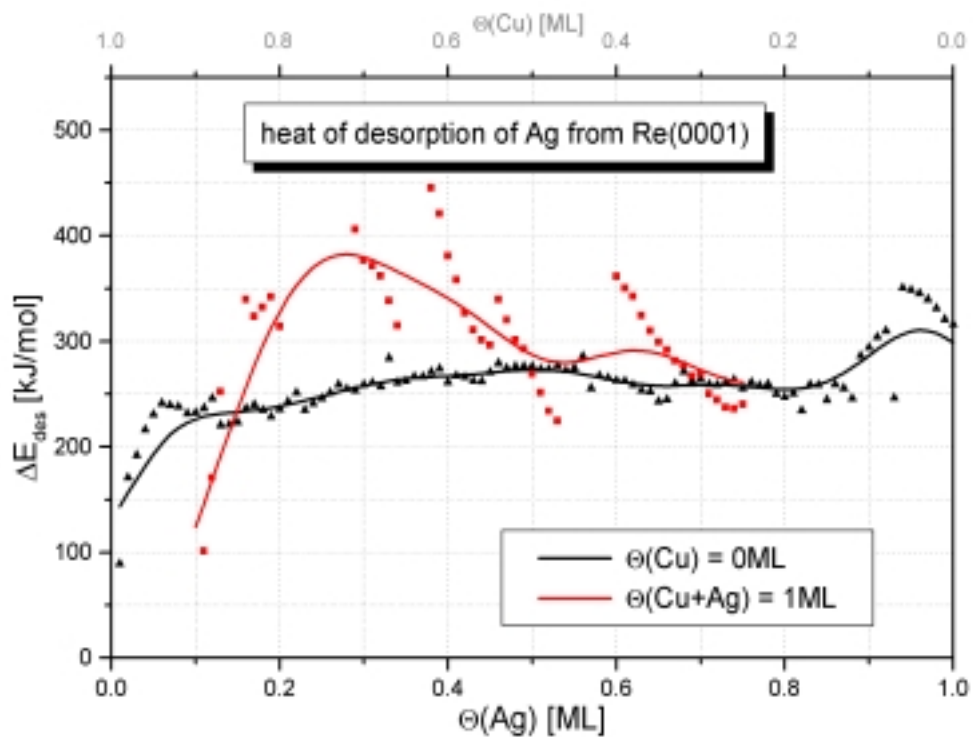
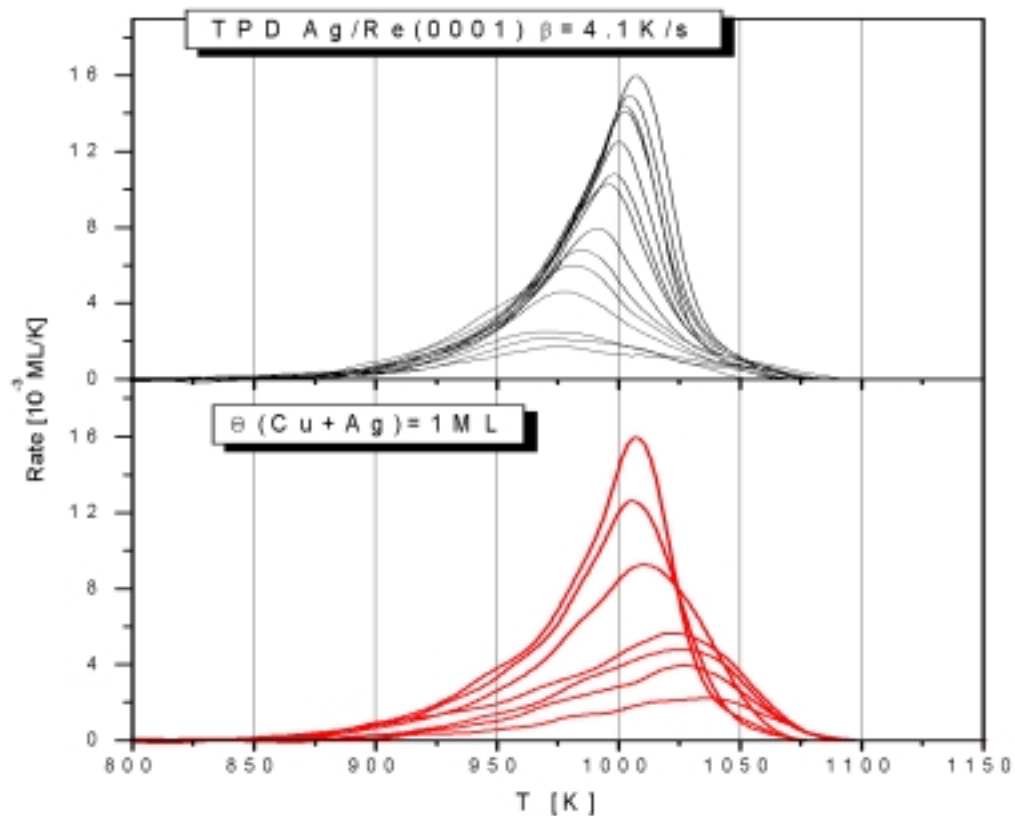


Ag-TPD-spectra Ag/Cu/Re(0001), $\beta=4.1\text{K/s}$ main parameter: Ag coverage

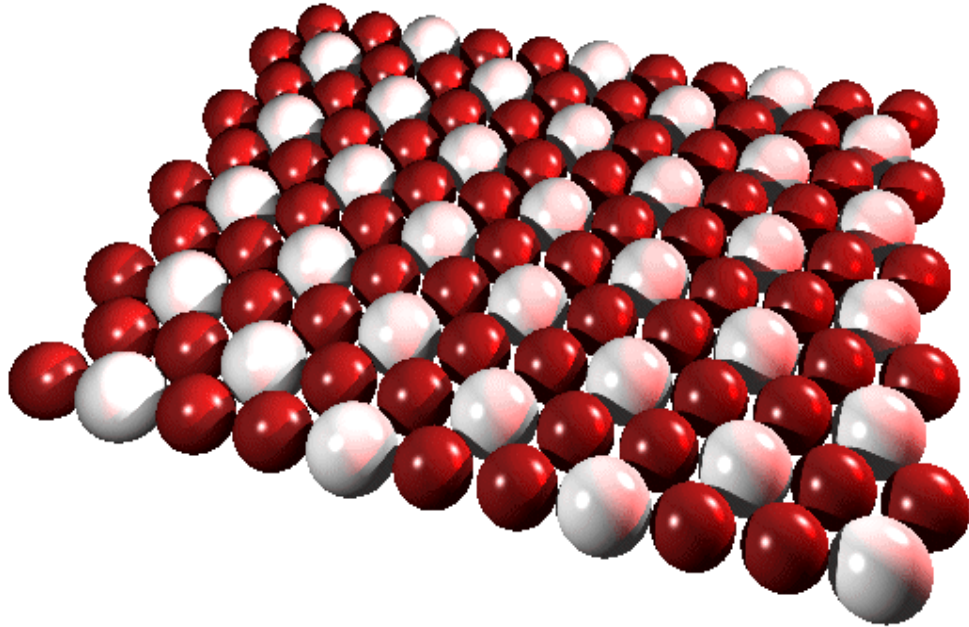


red: one layer copper + silver

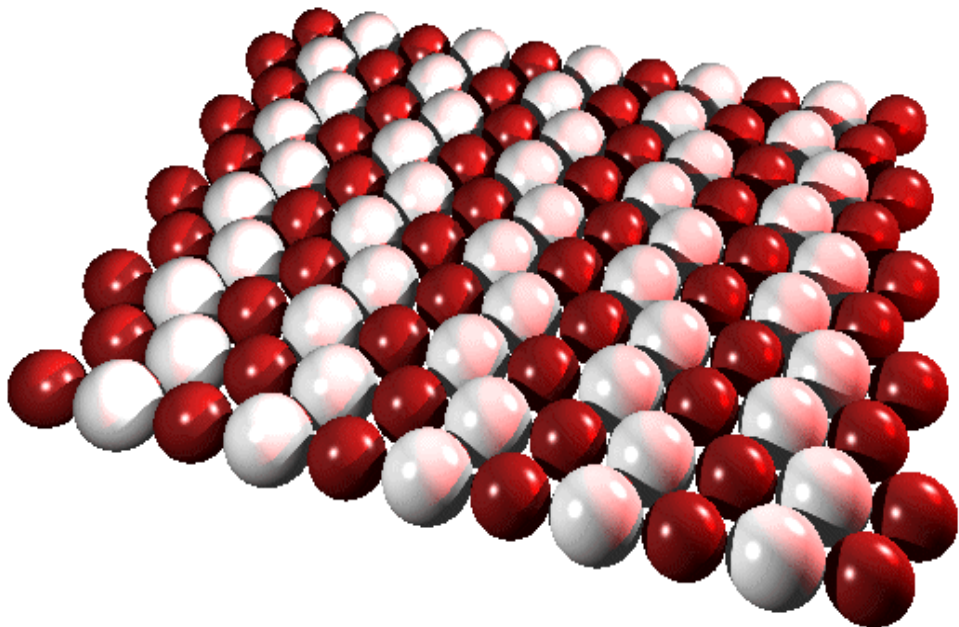
submonolayer desorption of Ag from the clean Re(0001) surface and from a Cu matrix



Suggestions for the distribution of silver and copper in the surface alloy



ratio of silver / copper = 1:2

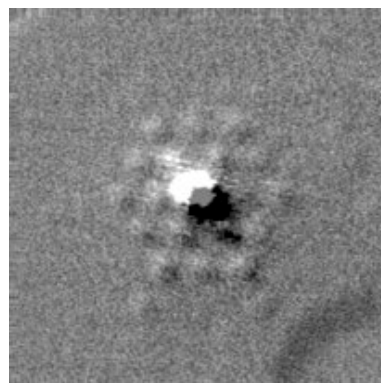


ratio of silver / copper = 1:1

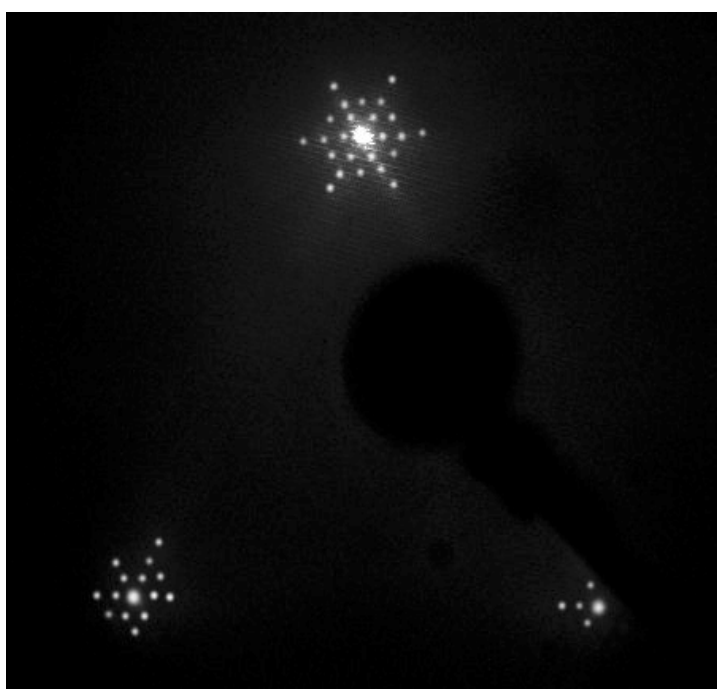
LEED pattern of a 2.2 ML Ag + 2.2 ML Cu - alloy film



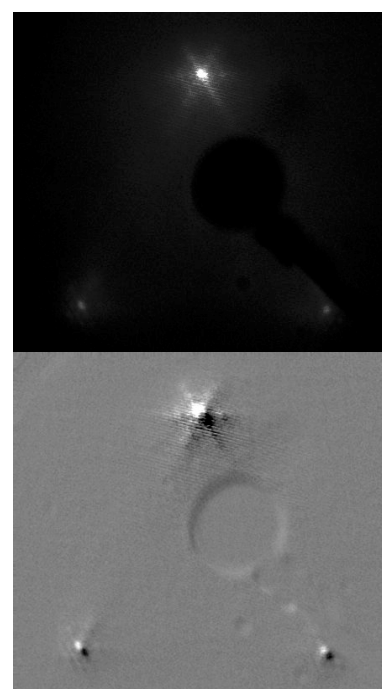
**(0,0)
beam
17.6 eV**



(25 x 25) superstructure



54.7 eV



Summary:

Ag and Cu form a continuous series of 2D mixed surface crystals, as a result of the registry with the Re lattice and the two-dimensionality

Films up to 10 ML thickness exhibit a characteristic crystallography

Ag-Cu interactions seem to be stronger than Ag-Ag interactions

Future work:

STM, XPS and CO-TPD measurements

Investigations of other binary systems: Ag-Au/Re and Cu-Au/Re